

Nanoscale Friction of CVD Single-Layer MoS₂ with Controlled Defect Formation

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ABSTRACT

Two-dimensional (2D) layered nanomaterials such as graphene, molybdenum disulfide (MoS₂), or tungsten disulfide offer a promising solution in areas of solid-state lubrication, due to their excellent mechanical properties as well as low friction. However, defects can influence their friction and reduce their superior tribological properties. Thus, it is crucial to understand the effects of defects on sliding behavior in 2D nanomaterials, to foster a functional strategy for utilizing 2D nanomaterials as solid-state tribological films. In this study, frictional effects of defects, grain boundaries, and atomic-scale structural defects were explored on chemical vapor deposition (CVD) grown single layer MoS₂. Selective patterning of defects into MoS₂ was accomplished *via* controlled irradiation of helium ions with varying ion doses. The friction of MoS₂ was characterized by friction force microscopy (FFM) and was found that friction depends on the defect formation controlled by helium ion irradiation. This approach offers a correlation between surface topography, defects and friction. Understanding the relative friction of MoS₂ in the

presence of different levels of defects is foundational to studying tribological properties of a single layer MoS₂ at both nanoscales and macroscales.

KEYWORDS: molybdenum disulfide (MoS₂), nanoscale friction, controlled defect formation, helium ion beam irradiation, friction force microscopy (FFM)

1. Introduction

Roughly 30% of the world's generated energy is wasted due to various types of mechanical friction every year [1-3]. Friction is the origin of wear, tear and eventual failure of mechanical systems, making its elimination a lucrative economic proposition [4]. Lubrication strategies depend on application environment. Liquid lubrication, which provides high tribological performance, cannot be used in all mechanical systems. In harsh environments, space crafts, and micro/nano systems – where liquid lubrication cannot be utilized – solid-state lubricants can replace liquid lubricants [5]; but dry friction in solid-state lubricants is generally higher than in their liquid counterparts. Therefore, materials for high-performance solid-state lubricants, ideally demonstrating superlubricity, attract interest and research in tribology community [6, 7].

Two-dimensional (2D) nanomaterials, which are crystalline structures a few atomic layers thick, have been explored in various areas of research due to their excellent optical, electrical and mechanical properties. Among this diverse material group, graphene and molybdenum disulfide (MoS₂) have been studied extensively as solid-state lubricants due to their intrinsically excellent tribological and anti-wear properties [8-16]. Most of the studies have been focused on demonstrating the fundamental frictional characteristics of mechanically exfoliated 2D nanomaterials on SiO₂/Si substrates, using friction force microscopy (FFM). They include the mechanisms of nanoscale friction as a function of thickness (layer)-dependence and friction anisotropy [14, 17, 18]. Research shows that the friction of 2D nanomaterials

decreased with the increase in the number of layers and is attributed to various factors, such as adhesion with an underlying substrate, interface structure, and out-of-plane stiffness.[14] In addition, frictional anisotropy was discovered in mechanically exfoliated graphene and MoS₂ using FFM, where the underlying mechanism was proposed to be ripples in domains. These ripples lead to anisotropic puckering and increased contact surface area with an atomic force microscopy (AFM) tip [17].

Although there are many studies on the nanoscale friction of small (few, or tens of micrometers), defect-free, mechanically exfoliated samples; offering insight into the friction of 2D nanomaterials as well as molecular-level frictional behavior as solid-state lubricants; the research is sparse on CVD grown graphene or MoS₂. CVD grown materials enable wafer-scale synthesis, which can be directly grown or indirectly transferred onto a large area of target substrates as solid-state tribological films.[19-22] However, unlike mechanical exfoliation, CVD grown 2D nanomaterials have polycrystalline domains with grain boundaries [23, 24], as well as a variety of defects and surface contaminants, including wrinkles and atomic structural defects, which may play a role in the material's surface friction [21, 22, 25].

In this work, we explore nanoscale friction of CVD grown single layer MoS₂. A continuous single layer MoS₂ film grown on a SiO₂/Si substrate has multiple grains and grain boundaries where friction was found to be significantly different; specifically, friction at grain boundaries can be similar to the base substrate. To investigate the effect of defects on the friction of MoS₂, we intentionally introduced different levels of defects by precisely controlled helium ion irradiation in a helium ion microscope (HIM) as described by the schematic in Figure 1. A focused helium ion beam has a minimum diameter of ~0.5 nm [26], allowing for high resolution nanomaterial imaging and milling [27-30]. Helium ion dose can also be controlled resulting in precise irradiation outcomes in localized areas of crystalline structures, with helium ion implantation, atomic lattice distortion, vacancy formation, amorphization, and sputtering/milling [31-37]. We used a 25 keV beam and doses ranging from 10¹³ to 5×10¹⁶ ions/cm², spanning a level of material damage where at the lower end, no observable change in Raman spectroscopic measurements occurred,

to complete sputtering of the MoS₂ film. The relative friction of the irradiated MoS₂ film was qualitatively investigated via FFM, which demonstrated a transitional change with the different levels of defect formation.

2. Methods

2.1. Helium ion beam imaging and irradiation

The helium ion microscope (HIM, Zeiss Orion NanoFab) was utilized for both high-resolution imaging and the irradiation experiments of the CVD single layer MoS₂ sample purchased from a vendor (6CarbonTehcnology, www.6carbon.com), using a helium ion beam with an acceleration voltage of 25 kV. The helium ion microscope chamber was pumped to a high vacuum at a pressure of $\sim 3 \times 10^{-7}$ Torr for both imaging and the irradiation experiments. The two irradiation experiments were conducted by exposing ions on a 2×3 array of square patterns with the beam current of ~ 5 pA and irradiation spot-to-spot distance of 10 nm×10 nm for a various dwell time, which makes different ion irradiation doses ranging from 10^{13} to 5×10^{16} ions/cm².

2.2. Atomic force microscopy imaging

All the surface topography and lateral deflection imaging of MoS₂ in this work were conducted using a NanoIR2-s AFM, commercially available from Anasys Instruments, Santa Barbara, CA, with the same highly doped silicon tip (tip radius below 10 nm, spring constant of 0.2 N/m and resonance frequency of 13 kHz) in a contact mode. The surface topography and lateral deflection were imaged with a resolution of 256×256 or 512×512. The AFM set point (relevant to a normal load applied to the sample by an AFM tip) and scan speed were varied for 0.55~0.91 V and 0.3~0.5 Hz, respectively, but the AFM settings were maintained constant within an AFM image. The lateral deflection images obtained from the AFM scans in the trace and retrace directions were subtracted and divided by two to extract friction images and surface

line profiles of friction signals. The variation of the AFM scan settings including laser alignment, scan speed and applied load (set point) can result in different lateral deflection signal amplitudes even on the same material domain, but the lateral deflection signals within the image is sufficient to provide the qualitative analysis for the difference in friction along different material domains of interests. The analysis for friction between two different images were conducted by considering relative friction to the same referenced material domain, which is also reasonable to compare the friction. Imaging processing of all the AFM images was implemented using Gwyddion version 2.53.

3. Results and discussion

Figure 2 shows the HIM images of CVD single-layer MoS₂ grown on the SiO₂/Si substrate. Most of the area is a continuous film as shown in Figure 2(a). The bright areas in Figure 2(b) are the MoS₂ film and the dark areas are the substrate. Additionally, optical microscopy images of the MoS₂ film are provided in the supplementary material Figure S1 to verify that the film is mostly continuous and monolayer. The surface of the MoS₂ film has some contaminants, possibly deposited during the synthesis which may attribute to the increase in surface friction of the MoS₂, as shown in the supplementary material (Figure S2).

Figure 3 shows the surface topography and friction images of MoS₂, using FFM. FFM is a subset of a contact-mode AFM where a cantilever tip is rastered across a sample surface, producing a vertical and lateral deflection images simultaneously. Vertical deflection images reflect the sample topography whereas lateral deflection images contain information on the surface friction, which enables the identification of different material domains and grain boundaries. The lateral deflection images obtained from the AFM scans in the trace and retrace directions were subtracted and divided by two to extract friction images. It is worth noting that the variation of the AFM scan settings can result in different lateral deflection signal amplitudes even on the same material domain, but the lateral deflection signals over the

same scanned image, which means the same AFM scan settings, is sufficient to provide qualitative analysis of friction along the different material domains of interests. Figures 3(a) and 3(b) show the surface topography and the corresponding friction images of a continuous MoS₂ region, while the imaging results of a MoS₂/SiO₂ interface are provided in Figures 3(c) and 3(d). Grain boundaries of MoS₂ are where two adjacent crystalline domains (grains) meet together during a growth process, which has a different atomic structure but no measurable topographic change from the crystalline domains. Thus, the grain boundaries can be considered as atomic defects relative to the crystalline domains. Due to the defected nature of the grain boundaries, they have different interaction with an AFM tip during scanning, and thus, the friction imaging enables the identification of grain boundaries. Figure 3(b) shows the friction image of MoS₂, which clearly shows the distribution of grain boundaries, while no topographic difference of grain boundaries is observed in the surface topography image of Figure 3(a). Figures 3(c) and 3(d) show the surface topography and friction images of the interface between MoS₂ and the SiO₂/Si substrate, respectively. The step height at the interface was measured as 1.0 ± 0.4 nm, which confirms a single layer of MoS₂. (see the supplementary material, Figure S3) The friction image in Figure 3(d) demonstrates the different surface friction arising from the different material domains. The difference in friction between MoS₂ and the substrate can be unambiguously identified, demonstrating a much lower friction on MoS₂ than the SiO₂. Figure 3(e) compares the friction signals of the grain boundary and SiO₂ relative to the signals on the crystalline domain of MoS₂, along the white dashed line in Figures 3(b) and 3(d). The relative friction on the grain boundary and SiO₂ are approximately four times higher than that of the crystalline domain, which indicates that the grain boundary on MoS₂ can result in a similar level of friction to the SiO₂ and implies that the friction of a MoS₂ film can be greatly influenced by the density of grain boundaries.

MoS₂ can have various types of defects including grain boundaries, S and Mo vacancies, lattice disorder, and so on, which can be generated during synthesis or by mechanical forces in operation as a

solid-state tribological film. Since the formation of defects can influence the tribological performance of MoS₂, it is important to understand the effect of nanoscale defects on its friction. To study the effect of defect formation on the friction of MoS₂, we intentionally generated defects by helium ion irradiation. Helium ion irradiation affects MoS₂ differently depending on a beam energy and an irradiation dose, resulting in the formation of atomic defects such as S or Mo vacancies to the continuous increase of the structural disorder finally to be sputtered at a large extent [36-40]. For example, the structural evolution of MoS₂ under helium ion irradiation at the energy of 25 keV or 30 keV occurs with respect to the ion dose range of 10¹³~10¹⁸ ions/cm² [36]. Leveraging the density of atomic defects by controlling the helium ion irradiation dose, which can give rise to the stronger interaction (higher adhesive force) with a counterpart material (an approaching AFM tip in this work), can lead to the increased friction of MoS₂ [25].

The helium ion irradiation was conducted using a Zeiss Orion NanoFab HIM. Six 3 μm × 3 μm squares were exposed to helium ions at an energy of 25 keV and ~5 pA beam current with ion irradiation doses ranging from 10¹³ to 5×10¹⁶ ions/cm². Two sets of irradiation experiments were performed and the results are shown in Figure 4 and Figure S4. Figure 4 shows surface topography and friction images of the MoS₂ film after the patterned helium ion irradiation with a dose from 5×10¹³ to 5×10¹⁶ ions/cm². Figure S3 shows the results with a dose ranging from 10¹³ to 10¹⁶ ions/cm². As shown in Figure 4(a), for the first two square patterns irradiated with ion doses of 5×10¹³ and 10¹⁴ ions/cm², there was no significant surface topographic change. Increasing the irradiation ion dose of 5×10¹⁴ and 10¹⁵ ions/cm² resulted in the change of surface topography, leading to the increase of surface roughness by incomplete milling of MoS₂. Further increasing the ion dose above 10¹⁶ ions/cm² resulted in the complete milling of the MoS₂ and exposing the substrate. The milled depths were measured as ~4.3 nm and ~5.1 nm for the ion dose of 10¹⁶ and 5×10¹⁶ ions/cm², respectively, which confirms the complete milling of the MoS₂ film as well as the partial sputtering of the substrate underneath.

Figure 4(b) shows the friction image of the MoS₂ film corresponding to the surface topography image in Figure 4(a). While no significant change was observed in the surface topography, the distinct frictional patterns can be identified at the low ion dose conditions. It highlights that helium ion irradiation can engineer the surface friction of MoS₂ without any observable topographic change by properly controlling the irradiation conditions. At the ion dose of 5×10^{14} ions/cm², the surface topography of the sputtered MoS₂ led to the significant increase in the friction as compared to the unexposed or lower ion dose irradiated MoS₂. At an increase ion dose above 10^{16} ions/cm², the friction comes from the helium ion irradiated SiO₂ substrate. Figure 5 shows the high-resolution images and cross-sectional profiles for the square patterns irradiated at a dose of 10^{14} and 5×10^{14} ions/cm², respectively. As seen in Figures 5(a)-5(c), it is clear that no topographic change is observed at a dose of 10^{14} ions/cm² while the relative frictional signal is measured as much as ~6 mV higher than the surrounding unexposed region of MoS₂. At an irradiation dose of 5×10^{14} ions/cm², more prominent increase of the relative friction signal on the square pattern was measured as ~15 mV higher than the unexposed MoS₂. The similar trend was observed in another set (ion dose range of 10^{13} ~ 10^{16} ions/cm²) of the irradiation experiments whose results are provided in the supplementary material (Figure S4). That is, the relative friction increases with increasing ion dose which results in atomic defect formation to the partial sputtering of MoS₂ and the relative friction is reduced at an ion dose of 10^{16} ions/cm² by the complete mill of MoS₂. It is worth noting that during the helium ion irradiation, the interaction of incident helium ion beam-induced secondary electrons with hydrocarbon molecular adsorbents over the substrate can deposit a thin carbon film, which can influence surface properties of MoS₂. However, the surface concentration of hydrocarbon molecular adsorbents is low since the irradiation experiment was conducted in a high vacuum at a pressure of $\sim 3 \times 10^{-7}$ Torr and the sample was stored in the HIM chamber at least for five hours before starting the irradiation experiments. At the low level of hydrocarbon molecules, the deposition occurs under the surface diffusion limited regime resulting in carbon deposition surrounding the irradiated region by a long range of the

secondary electron spatial distribution and then an apparent carbon film formed with a sufficient ion dose. Since our experimental observation with a dose range of $10^{13}\sim 5\times 10^{16}$ ions/cm² indicates no topographic evidence for carbon deposition, rather the milling out of the substrate, we can conclude that no carbon is deposited and the effect of carbon deposition on the relative friction of helium ion-irradiated MoS₂ is negligible.

To summarize the effects of defect formation on the frictions of MoS₂, the relative friction signal of each square pattern, normalized to the helium ion irradiated SiO₂ substrate (square pattern exposed at the highest ion dose), are plotted as a function of the irradiation dose as shown in Figure 6(a). Figure 6(b) shows the magnified plot for the ion dose range of $0\sim 10^{15}$ ions/cm² to present the effect of helium ion irradiation more clearly. The irradiation data set 1 and set 2 in Figure 6 represents the results from the irradiation experiments shown in Figure 4 and Figure S4, respectively. The relative friction signal was normalized since the measured signal can vary by AFM imaging conditions such as a set point (normal force on the sample by an AFM tip) and a scan speed. Three distinct ranges of ion irradiation doses are identified as seen in Figure 6. At an ion dose range of $0\sim 10^{14}$ ions/cm², the linear increase of the friction without the observable surface topographic change, which results from the increased density of atomic defects. At a dose below 10^{15} ions/cm² but higher than 10^{14} ions/cm², the friction is influenced by the combinatorial effect of the significantly damaged MoS₂ and the underneath substrate with a surface roughness whose root-mean-square (rms) roughness is around ~ 1.7 nm. Further increasing irradiation dose higher than 10^{15} ions/cm² milled out MoS₂ completely and also partially sputtered the substrate resulting in the smoother surface whose rms roughness is reduced as ~ 1.1 nm and ~ 0.8 nm after irradiation at a dose of 10^{16} and 5×10^{16} ions/cm², respectively and finally reducing the relative surface friction.

4. Conclusions

In conclusion, we present a novel approach to screen the effect of defects on the friction of a single layer MoS₂. The approach is to use finely controlled helium ion irradiation to generate different levels of defects on MoS₂ and to investigate the resulting friction with FFM. Remarkably, a low density of atomic defects on MoS₂, with a helium ion dose of 10^{13} ions/cm², can result in the significant increase of friction, even though MoS₂ maintains its 2D nature of structural integrity at nanoscale. With an increased helium ion dose, beyond that of inducing a low density of atomic defects, the MoS₂ film is sputtered which increases the surface roughness and friction with the combinatorial effect of surface topography as well as stronger interaction between damaged MoS₂ and the AFM tip [25]. This work demonstrates a distinct nanoscale mechanism of surface friction change of MoS₂ under external energy input inducing defect formation and also suggests the significance of a MoS₂ film synthesis achieving high structural and compositional integrity with defect-free and large-area crystalline domains (that is, low density of grain boundaries) as solid-state tribological applications, while a MoS₂ film by itself is known to have very low friction and a superior tribological performance. In addition, we also highlight the capability for selective nanoscale patterning of friction on MoS₂ with the controlled helium ion irradiation, which can provide intriguing opportunities to any application such as micro/nano mechanical systems or energy harvesting systems, possibly requiring the control of frictions.

Declaration of Competing Interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

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Appendix A. Supplementary material

The supplementary material is available for this paper showing optical microscopy images and additional HIM images of the CVD single layer MoS₂ sample and the AFM imaging results demonstrating the monolayer thickness of the MoS₂ sample as well as the results of the irradiation experiment 2.

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Figures:

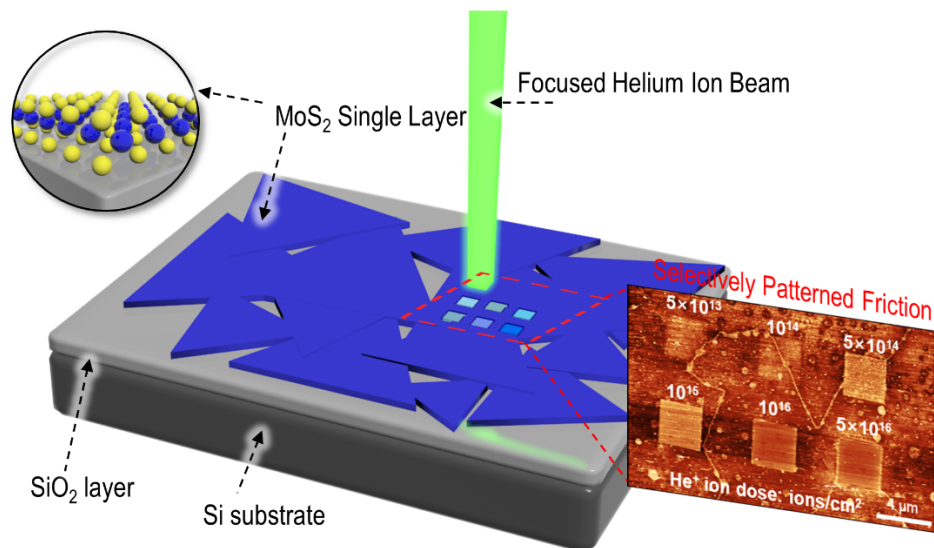


Figure 1. Schematic description of the experiment approach enabling the selectively patterned surface friction on a single layer MoS₂ using precisely controlled helium ion beam irradiation.

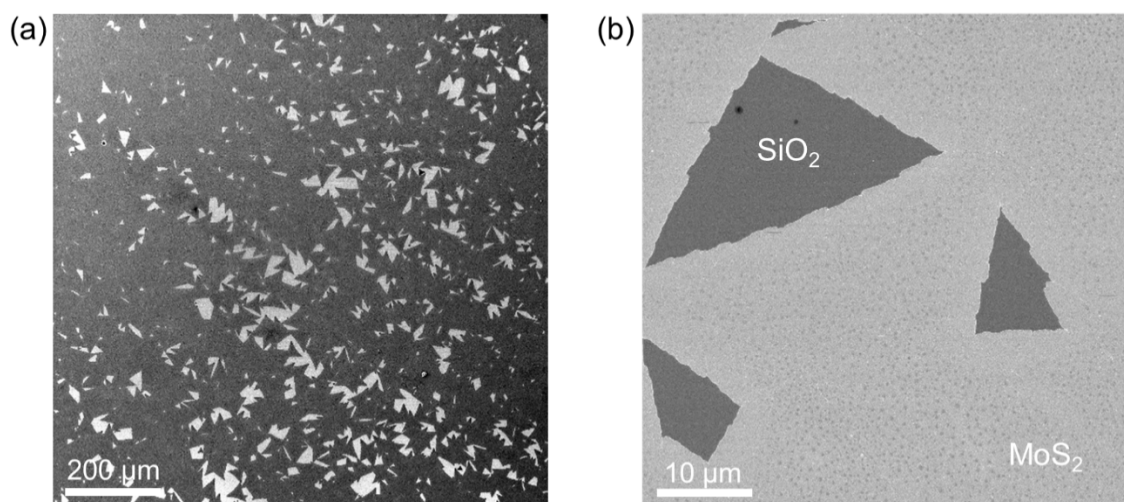


Figure 2. Helium ion microscopy secondary electron (iSE) images of a single layer MoS₂ film grown on the SiO₂/Si substrate: (a) a large-area continuous film with some discontinuities exposing the underneath substrate and (b) a high-resolution image of the MoS₂ film.

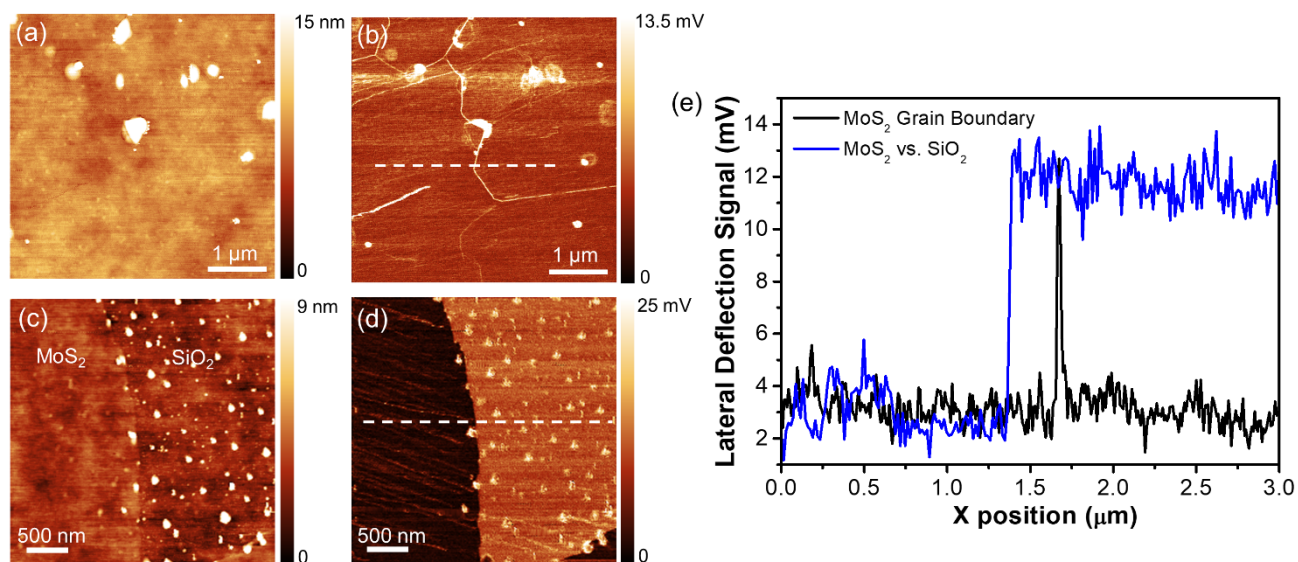


Figure 3. (a) Surface topography and (b) friction images of MoS₂ with grain boundaries, and (c) surface topography and (d) friction images of the MoS₂/SiO₂ interface. (e) Surface line profiles (white dashed lines) to compare the relative friction of MoS₂ grain boundaries vs. SiO₂ relative to the crystalline domain of MoS₂.

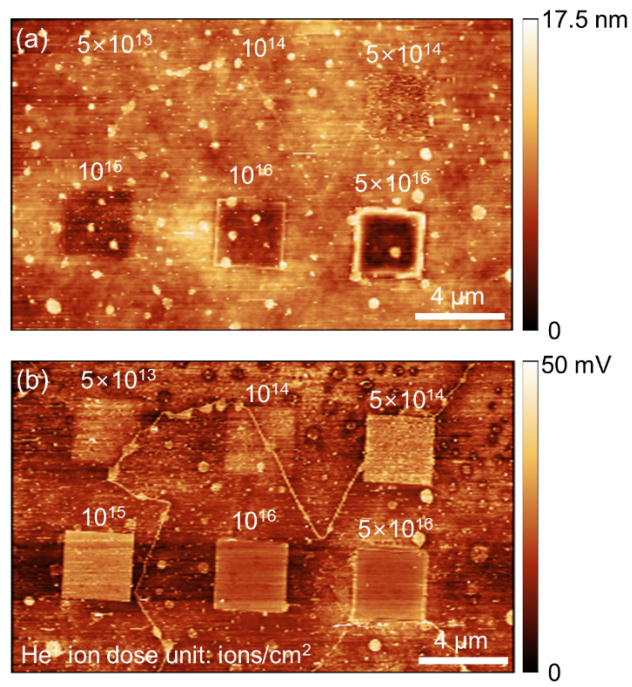


Figure 4. (a) Surface topography and (b) friction images of MoS₂ patterned by controlled helium ion irradiation to demonstrate the effect of irradiation-induced defect formation on the friction of MoS₂.

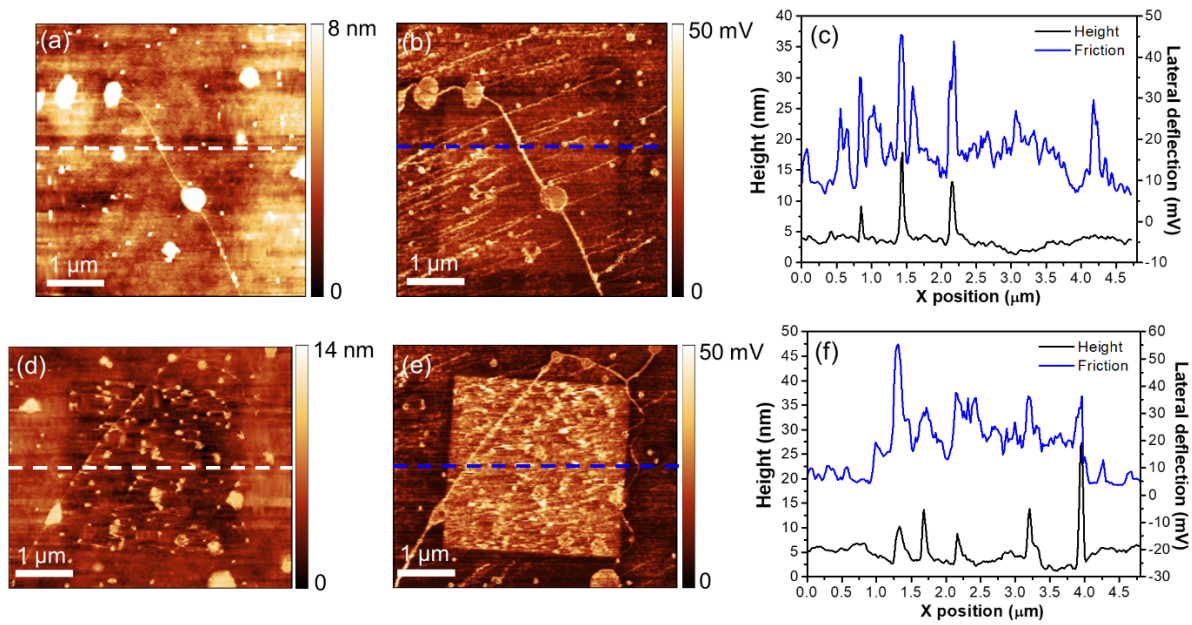


Figure 5. High-resolution surface topography and friction images of MoS₂ after helium ion irradiation: (a) surface topography and (b) friction images after ion irradiation at a dose of 10^{14} ions/cm² and (c) the corresponding surface line profiles, and (d) surface topography and (b) friction images after ion irradiation at a dose of 5×10^{14} ions/cm² and (f) the corresponding surface line profiles.

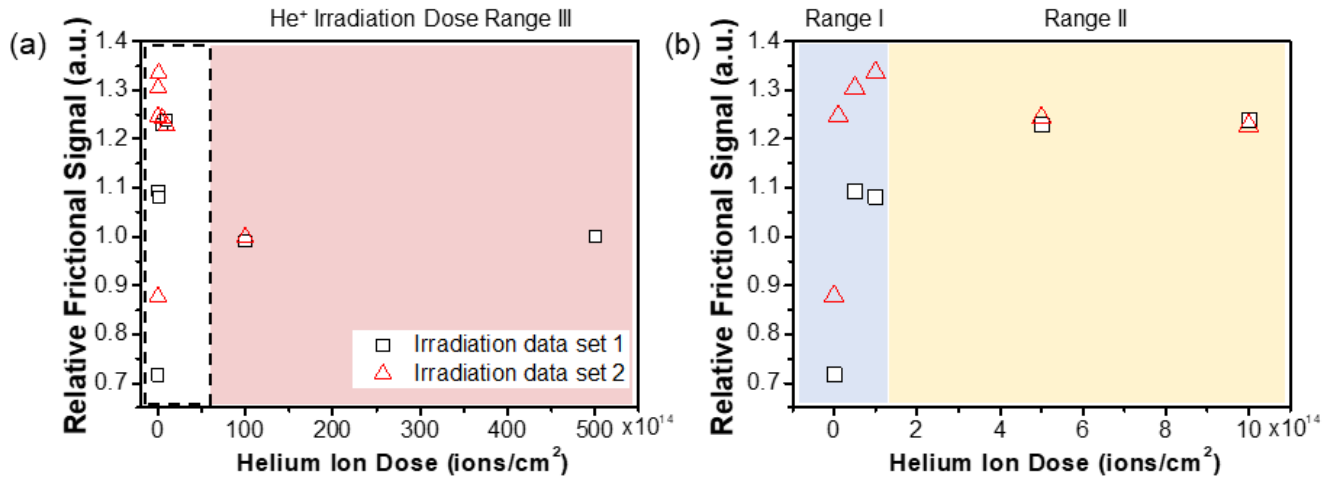


Figure 6. (a) Relative friction of MoS₂ normalized to that of the helium irradiated SiO₂/Si substrate to demonstrate the effect of helium ion irradiation dose (that is, different levels of defect formation) on the friction of MoS₂, summarized from the results done in the two irradiation experiments and (b) the magnified plot for the black dashed box in (a).

Supplementary Material for “Nanoscale Friction of CVD Single-Layer MoS₂ with Controlled Defect Formation”

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Figure S1 shows optical microscopy images of the MoS₂ film over the multiple areas of the sample. Figure S1(a) verifies that the film is mostly continuous and some areas near the edge of the sample substrate have a discontinuous MoS₂ film showing triangular shapes of MoS₂ flakes. Figures S1(b) and S1(c) are the magnified images, showing that the image color contrast of the MoS₂ film is uniform. In addition, the dots in red dashed circles in Figure S1(c) represent the nucleation sites which are the evidence that bi-layer MoS₂ did not start to growth yet. Along with the AFM measurement of MoS₂ film thickness shown in Figure S3, it can be concluded that the film is monolayer and no bi- or tri-layer is present in our sample. Based on the optical microscopy images, we can conclude that the shape and size of grain boundaries can be arbitrarily distributed over the continuous film.

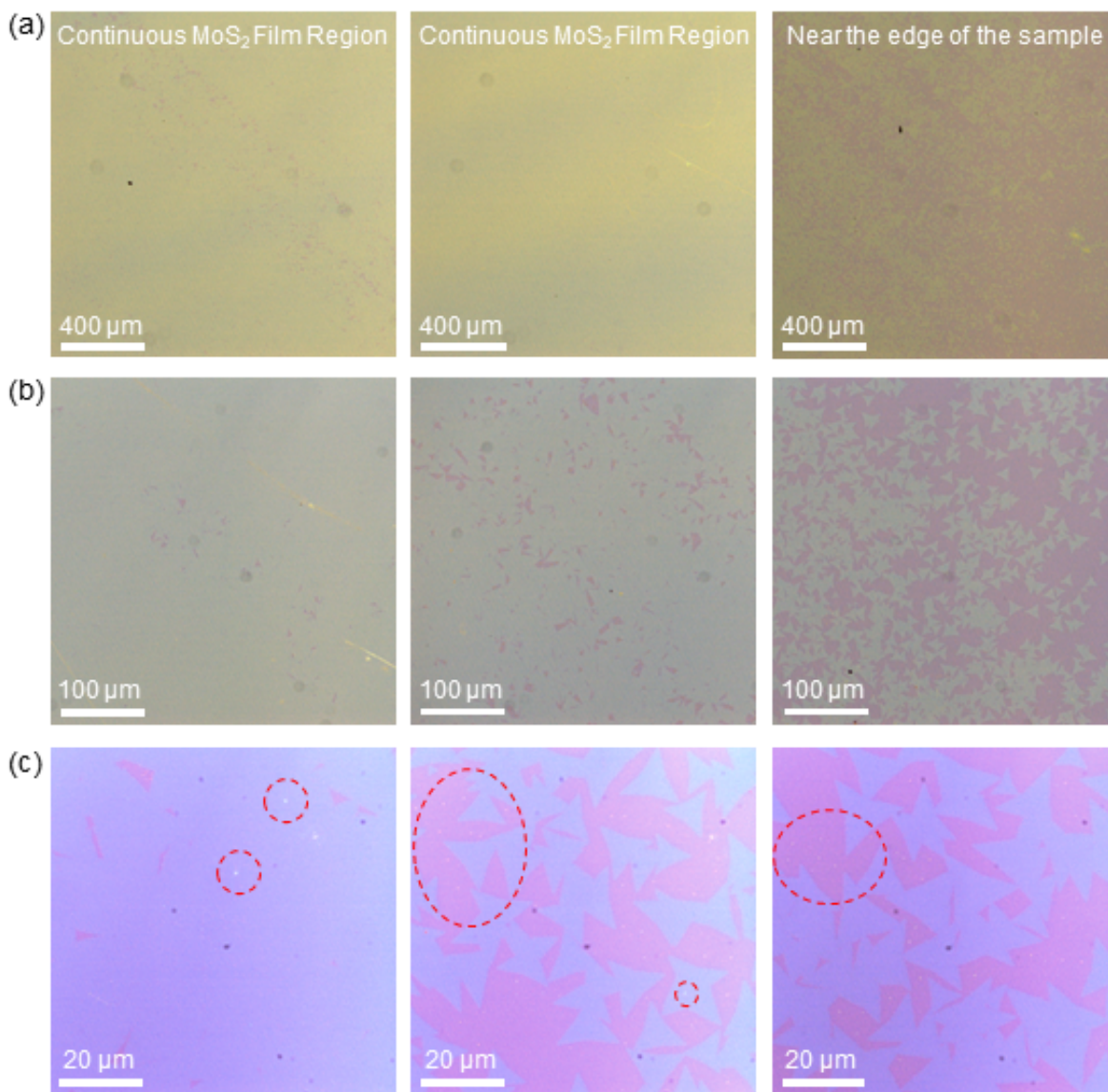


Figure S1. Optical microscopy images of the MoS₂ film with different magnifications, showing the film is mostly continuous and monolayer: (a) 50×, (b) 200× and (c) 1000×.

Figure S2 shows the HIM images of the MoS₂ film. Surface contamination over the film might be deposited during the CVD synthesis process, which can result in locally high friction over the MoS₂ film

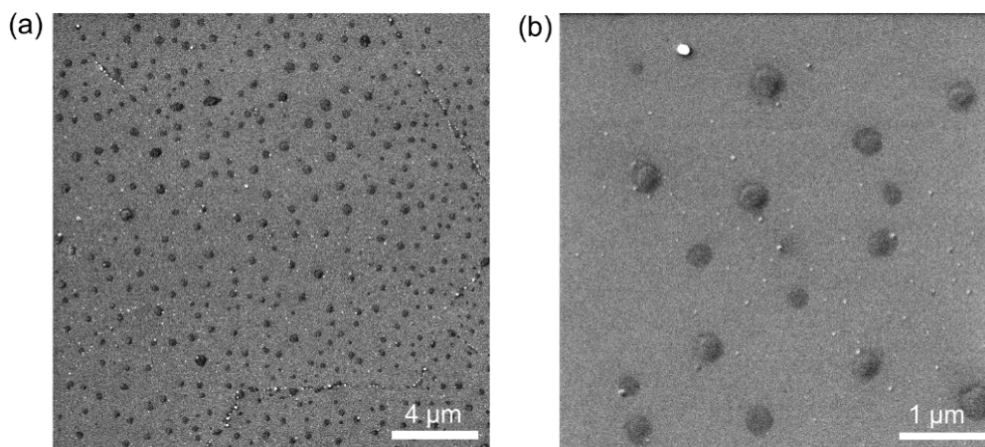


Figure S2. (a) HIM surface topography image of the MoS₂ film with (b) the zoomed-in image, showing the droplet-like surface contamination.

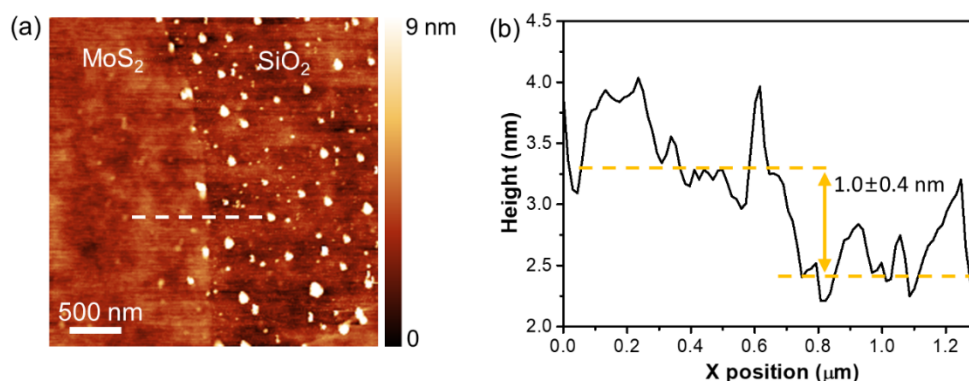


Figure S3. (a) Surface topography image of MoS₂/SiO₂ interface (b) cross-sectional profile of white dashed line. This profile shows 1.0 ± 0.4 nm step height which indicates a single layer of MoS₂.

Figure S3 (a) shows the AFM surface topography of the interface between MoS₂ and the SiO₂/Si substrate, and the cross-sectional profile along the white dashed line in Figure S3(a) is shown in Figure S3(b). Figure S3(b) shows the step height of 1.0 ± 0.4 nm between MoS₂ and SiO₂/Si substrate, confirming a single layer of MoS₂.

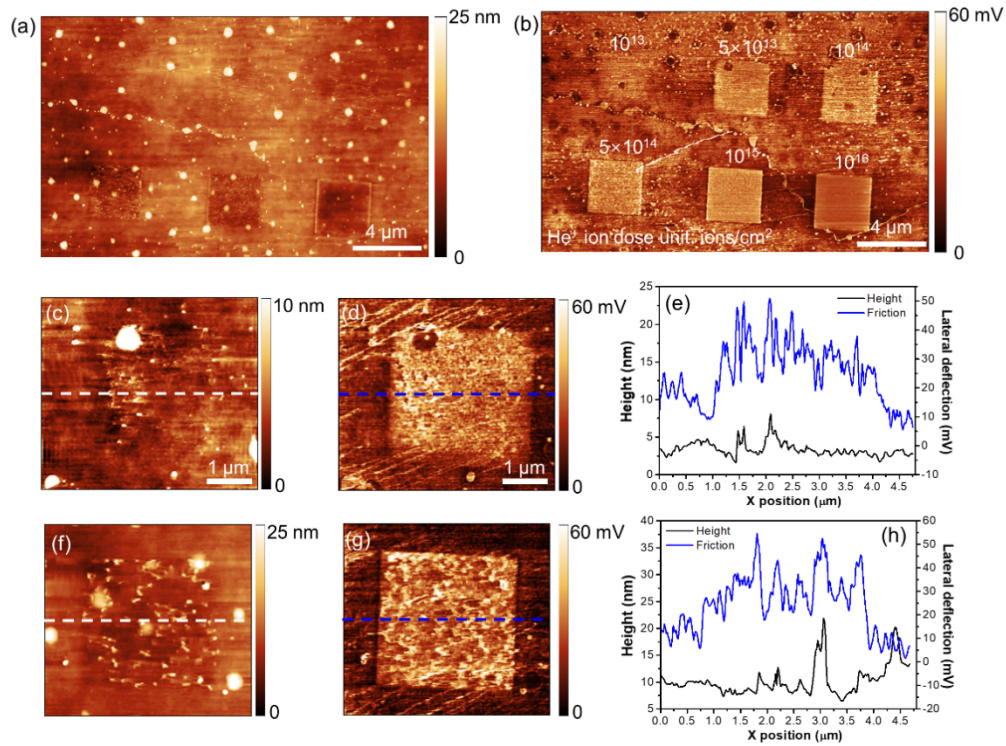


Figure S4. (a) Surface topography and (b) friction images of the second set of the helium ion irradiation experiments. (c), (d) High-resolution surface topography and friction images after the ion irradiation at a dose of 5×10^{13} ions/cm² and (e) the corresponding surface line profiles, and (f) surface topography (g) friction images after the ion irradiation at a dose of 5×10^{14} ions/cm² and (h) the corresponding surface line profiles.

Figure S4 shows the result for the second set of the helium ion irradiation experiments with the ion doses from 10^{13} to 10^{16} ions/cm². The resulting square patterns were measured using FFM. Figure S4(a) shows there was no significant surface topographic change for square patterns irradiated with ion doses from 10^{13} to 5×10^{14} ions/cm², whereas there were distinct changes in surface topography images with ion doses of 10^{15} and 10^{16} ions/cm². Figure S4(b) shows the lateral deflection image of the MoS₂ film corresponding to the surface topography image in Figure S4(a). There were significant frictional

signal changes for patterns irradiated with ion doses from 5×10^{13} to 10^{16} ions/cm², while there was only slight change with ion doses of 10^{13} ions/cm². With ion doses of 10^{16} ions/cm², frictional signal became similar with that of underlying SiO₂/Si substrate, which indicates MoS₂ can be milled out with this ion dose. Figures S4(c)~S4(h) show the high-resolution AFM images and cross-sectional profiles for the square patterns irradiated with ion doses of 5×10^{13} ions/cm² and 5×10^{14} ions/cm². Figure S4 (c), (f) shows there was no surface topographic change at low ion dose, while there were significant frictional signal changes in both low and high ion doses as shown in Figures S4(d) and S4(g).